

- CASE

# **5<sup>th</sup> Generation CoolSiC<sup>™</sup> 1200V Schottky Diode**

#### SiC Diode

#### **Features**

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / no forward recovery
- Temperature independent switching behaviour
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Pb-free lead plating; RoHS compliant





Pin 1 and backside: Cathode 10 Pin 2: Anode

### **Potential applications**

- Drives
- Industrial power supplies: Industrial UPS
- Solar central inverters and Solar string inverter

#### **Product validation**

Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

## **Description**

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- Related Links: www.infineon.com/SiC









# **Key performance parameters**

Туре	<b>V</b> <sub>DC</sub>	I <sub>F</sub>	<b>Q</b> c	$oldsymbol{\mathcal{T}}_{vj,max}$	Marking	Package
IDK05G120C5	1200 V	5 A	24nC	175°C	D0512C5	PG-T0263-2



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#### **SiC Diode**



**Maximum ratings** 

#### **Maximum ratings** 1

Note:

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage $T_{\rm C} \ge 25^{\circ}{\rm C}$	$V_{RRM}$	1200	V	
Continuous forward current for $R_{th(j-c,max)}$ $T_C = 161^{\circ}C$ , D=1 $T_C = 135^{\circ}C$ , D=1 $T_C = 25^{\circ}C$ , D=1	I <sub>F</sub>	5.0 9.2 19.1	А	
Surge repetitive forward current, sine halfwave <sup>1</sup> $T_{\rm C}$ =25°C, $t_{\rm p}$ =10ms $T_{\rm C}$ =100°C, $t_{\rm p}$ =10ms	I <sub>F,RM</sub>	20 15	А	
Surge non-repetitive forward current, sine halfwave $T_c$ =25°C, $t_p$ =10ms $T_c$ =150°C, $t_p$ =10ms	$I_{F,SM}$	59 50	Α	
Non-repetitive peak forward current $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 \ \mu{\rm s}$	I <sub>F,max</sub>	472	А	
$i^{2}t$ value $T_{C} = 25^{\circ}C, t_{p}=10 \text{ ms}$ $T_{C} = 150^{\circ}C, t_{p}=10 \text{ ms}$	∫i²dt	17.4 12.5	A <sup>2</sup> s	
Diode $dv/dt$ ruggedness $V_R=0960 \text{ V}$	dv/dt	150	V/ns	
Power dissipation for $R_{th(j-c,max)}$ $T_C = 25^{\circ}C$	P <sub>tot</sub>	109	W	

<sup>&</sup>lt;sup>1</sup> Not subject to production test. The test was performed with 20000 pulses (two consecutive half-wave rectified sines with 10 ms period).



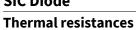


### **Maximum ratings**

Operating temperature	$T_{ m vj}$	-55175	°C
Storage temperature	$T_{stg}$	-55150	°C
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STD-020)	$T_{sold}$	260	°C

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### **SiC Diode**





# 2 Thermal resistances

Davamakay	Symbol	Conditions	Value			
Parameter			min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	$R_{th(j-c)}$		-	1.06	1.37	K/W
Thermal resistance, junction – ambient	$R_{th(j-a)}$	Leaded	-	-	62	K/W

#### **Electrical Characteristics**



### 3 Electrical Characteristics

### Static Characteristics, at $T_{vj}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Oille
DC blocking voltage	$V_{ m DC}$	$T_{\rm vj} = 25^{\circ}\text{C}, I_{\rm R} = 50 \mu\text{A}$	1200	-	-	V
Diode forward voltage	1/	<i>I</i> <sub>F</sub> = 5A, <i>T</i> <sub>vj</sub> =25°C	-	1.50	1.8	V
	$V_{F}$	$I_{\rm F}$ = 5A, $T_{\rm vj}$ =150°C	-	1.95	-	
Reverse current	1	V <sub>R</sub> =1200V, T <sub>vj</sub> =25°C	-	2.5	33	μА
	I <sub>R</sub>	V <sub>R</sub> =1200V, T <sub>vj</sub> =150°C	-	12	-	

### Dynamic Characteristics, at $T_{vj}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
raiailletei			min.	typ.	max.	Oilit
Total capacitive charge		$V_{R}$ = 800V, $T_{vj}$ = 150°C				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	24	-	nC
		<i>V</i> <sub>R</sub> =1 V, <i>f</i> =1 MHz	-	301	-	
Total Capacitance	С	V <sub>R</sub> =400 V, <i>f</i> =1 MHz	-	21	-	pF
		V <sub>R</sub> =800 V, <i>f</i> =1 MHz	-	17	-	

#### **Electrical Characteristics Diagrams**



#### **Electrical Characteristics Diagrams** 4

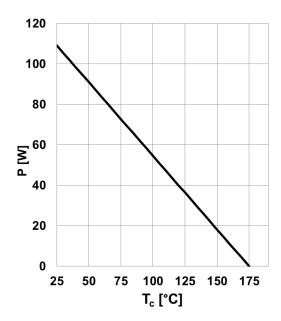


Figure 1. Power dissipation as function of case temperature,  $P_{tot}=f(T_c)$ ,  $R_{th(j-c),max}$ 

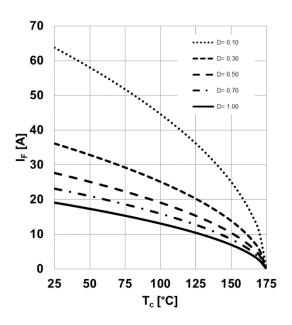


Figure 2. Diode forward current as function of temperature, parameter: T<sub>vj</sub>≤175°C,  $R_{th(j-c),max}$ , D=duty cycle,  $V_{th}$ ,  $R_{diff}$  @  $T_{vj}$ =175°C

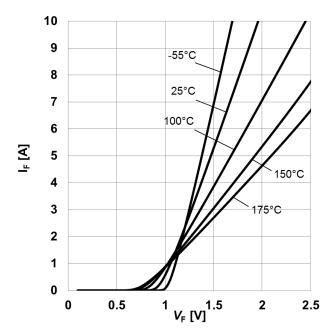


Figure 3. Typical forward characteristics,  $I_F = f(V_F), t_p = 10 \mu s, parameter: T_{vj}$ 

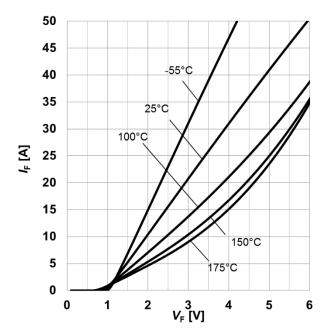
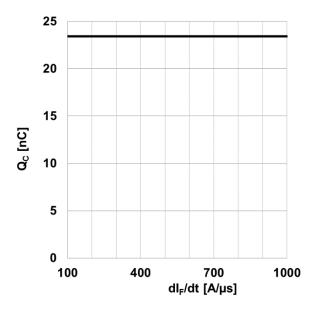


Figure 4. Typical forward characteristics in surge current,  $I_F = f(V_F)$ ,  $t_p = 10 \mu s$ , parameter:  $T_{vj}$ 

#### **Electrical Characteristics Diagrams**





1E-4

1E-5

1E-6

1E-7

150°C

1E-8

100°C

25°C

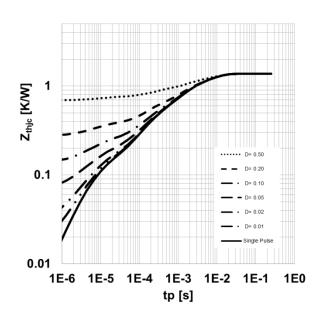
1E-9

200 400 600 800 1000 1200

V<sub>R</sub> [V]

Figure 5. Typical capacitive charge as function of current slope,  $Q_c=f(dIF/dt)$ ,  $T_{vj}=150^{\circ}C$ 

Figure 6. Typical reverse characteristics,  $I_R = f(V_R)$ , parameter:  $T_{vj}$ 



400 350 300 250 200 C [pF] 150 100 50 0 0 1 10 100 1000  $V_{R}[V]$ 

Figure 7. Max. transient thermal impedance,  $Z_{th,j-c} = f(t_P)$ , parameter:  $D = t_P/T$ 

Figure 8. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_{vj}=25^{\circ}C$ ; f=1 MHz

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### **Electrical Characteristics Diagrams**

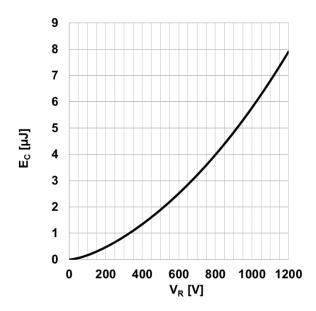


Figure 9. Typical capacitively stored energy as function of reverse voltage,  $E_{\rm C}=f(V_{\rm R})$ 

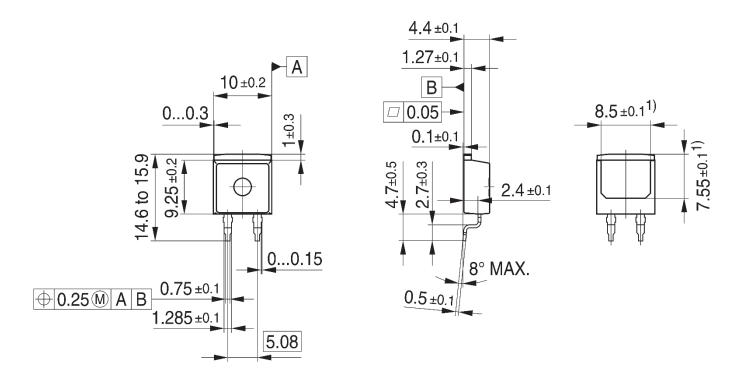
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#### **Package Drawing**



# 5 Package Drawing

#### PG-TO263-2



1) Typical

Metal surface min. X = 7.25, y = 6.9

All metal surfaces: tin plated, except area of cut

All dimensions do not include mold flash or protrusions

All dimensions are in units mm

The drawings is in complicance with ISO 128-30, Projection Method 1 [←♦]

### SiC-Diode

**Revision history** 



# **Revision history**

Document version	Date of release	Description of changes
V 2.0	2019-10-28	Final Datasheet
V 2.1	2021-07-14	Increased dv/dt ruggedness

#### **Trademarks**

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**Document reference** 

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